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|   | Application Number   |        | 10683929    |  |
|---|----------------------|--------|-------------|--|
|   | Filing Date          |        | 2003-10-09  |  |
| INFORMATION DISCLOSURE  | First Named Inventor | John ' | W. Rapp     |  |
| STATEMENT BY APPLICANT (Not for submission under 37 CFR 1.99) | Art Unit             |        | 2183        |  |
| ( Not lot Submission under or or it 1.00)                     | Examiner Name        | David  | J. Huisman  |  |
|   | Attorney Docket Numb | er     | 1934-013-03 |  |

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| Examiner Name David         |  | J. Huisman  |  |  |
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